



SURFACE MOUNT

Directional Coupler

TCD-20-4-75+

Mini-Circuits

75Ω

40 to 1200 MHz

FEATURES

- Wideband, 40 to 1200 MHz
- Excellent flatness, ±0.5 dB typ. each band
- Better performance than MA-COM EMDC-20-2-75
- Footprint compatible to EMDC-10-1-75
- Aqueous washable



Generic photo used for illustration purposes only

CASE STYLE: DB714

APPLICATIONS

- CATV

+RoHS Compliant

The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

ELECTRICAL SPECIFICATIONS AT 25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Frequency Range	—	40	—	1200	MHz
Mainline Loss ¹	40-500	—	0.5	0.9	dB
	500-870	—	0.6	1.0	
	870-1200	—	0.6	1.1	
Coupling	40-500	—	21±0.5	—	dB
	500-870	—	20±0.5	—	
	870-1200	—	19.5±0.5	—	
Coupling Flatness (±)	40-1200	—	±0.8	—	dB
Directivity	40-500	15	20	—	dB
	500-870	16	23	—	
	870-1200	14	20	—	
VSWR	40-1200	—	1.15	—	:1
Input Power	40-1200	—	—	1.0	W

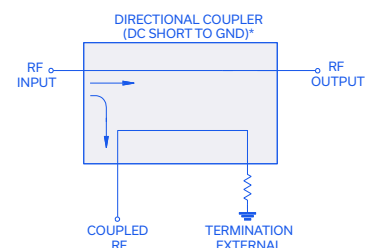
1. Mainline loss includes theoretical power loss at coupled port.

MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-40°C to 85°C*
Storage Temperature	-55°C to 100°C

Permanent damage may occur if any of these limits are exceeded.
* Case temperature is defined as temperature on ground leads.

ELECTRICAL SCHEMATIC



*Electrical schematic is for Directional coupler with internal transformer(s) and external termination





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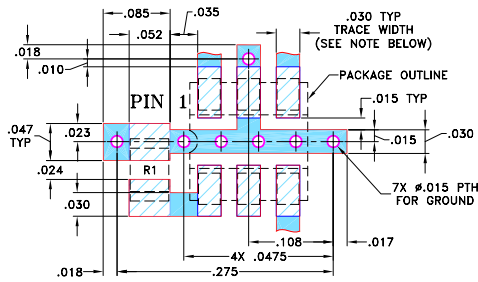
40 to 1200 MHz

PIN CONNECTIONS

INPUT	3
OUTPUT	4
COUPLED	1
GROUND	2
75Ω TERM EXTERNAL	6
NOT USED	5

PRODUCT MARKING: N/A

**DEMO BOARD MCL P/N: TB-72
SUGGESTED PCB LAYOUT (PL-010)**



RESISTOR R1: 75 ± 1% Ohm, 0805 SIZE

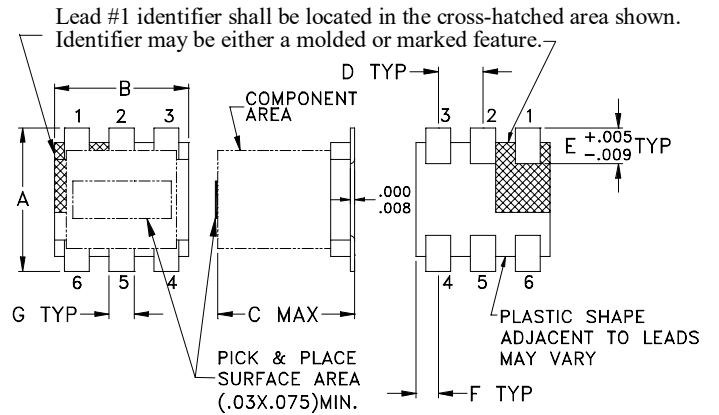
NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS 0.030" ± 0.002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.

2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

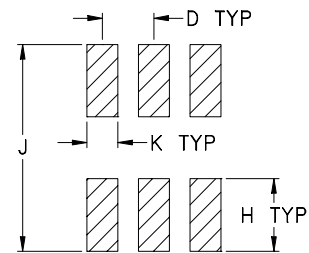
DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

OUTLINE DRAWING



PCB Land Pattern



Suggested Layout,
Tolerance to be within ±.002

OUTLINE DIMENSIONS (Inches/mm)

A	B	C	D	E	F
.160	.150	.160	.050	.040	.025
4.06	3.81	4.06	1.27	1.02	0.64
G	H	J	K		wt
.028	.065	.190	.030		grams
0.71	1.65	4.83	0.76		0.15

TAPE & REEL INFORMATION: F47



SURFACE MOUNT

Directional Coupler

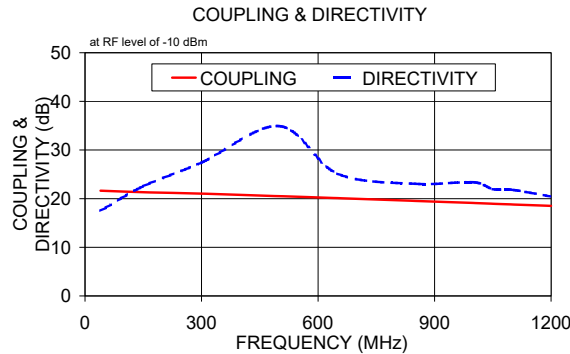
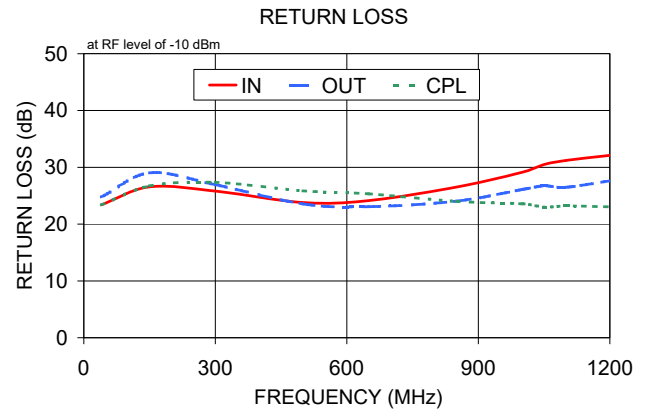
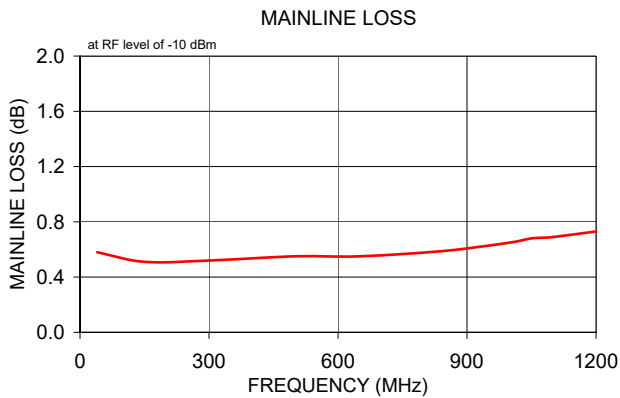
TCD-20-4-75+

75Ω

40 to 1200 MHz

TYPICAL PERFORMANCE DATA

Frequency (MHz)	Mainline Loss (dB)	Coupling (dB)	Directivity (dB)	Return Loss (dB)		
	In-Out			In	Out	Cpl
40.00	0.58	21.64	17.52	23.40	24.77	23.38
150.00	0.51	21.32	22.55	26.56	29.03	26.72
300.00	0.52	21.04	27.40	25.81	26.94	27.36
500.00	0.55	20.52	34.93	23.79	23.55	25.86
650.00	0.55	20.11	25.14	24.15	23.07	25.34
850.00	0.59	19.53	23.06	26.52	24.05	24.00
1000.00	0.65	19.12	23.38	29.12	26.11	23.57
1050.00	0.68	18.96	21.95	30.51	26.75	22.99
1100.00	0.69	18.81	21.82	31.20	26.49	23.19
1200.00	0.73	18.51	20.42	32.12	27.62	23.06



- NOTES**
- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
 - B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
 - C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html



Directional Coupler

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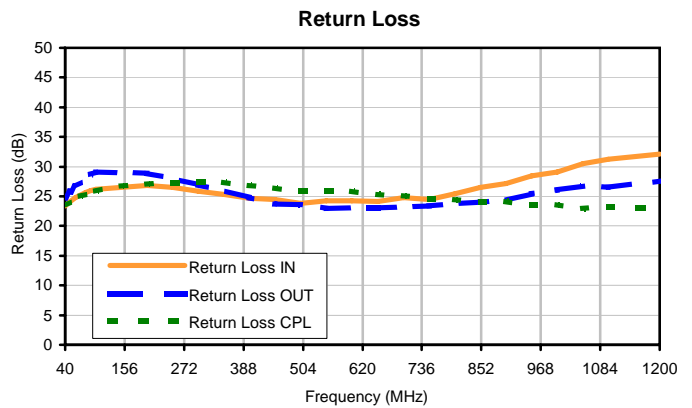
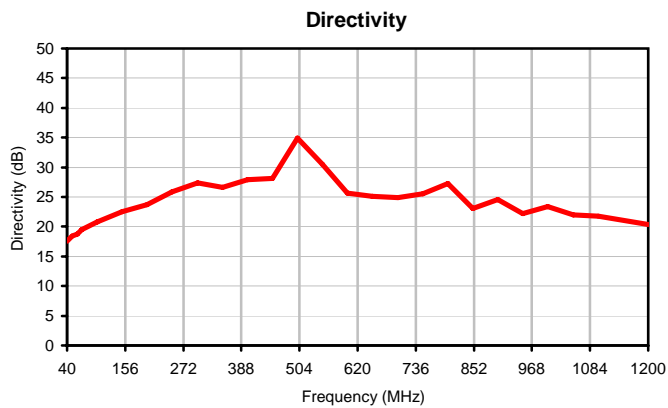
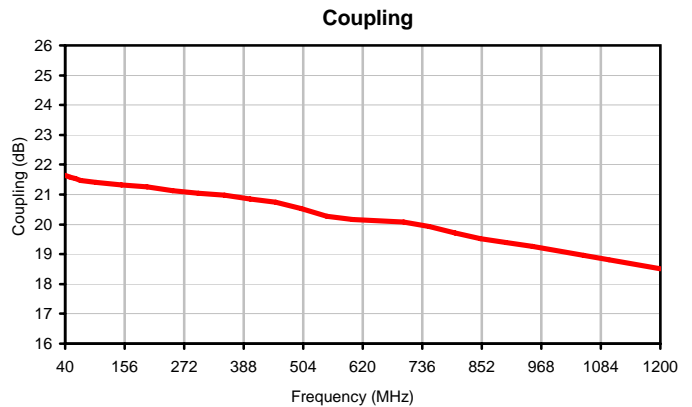
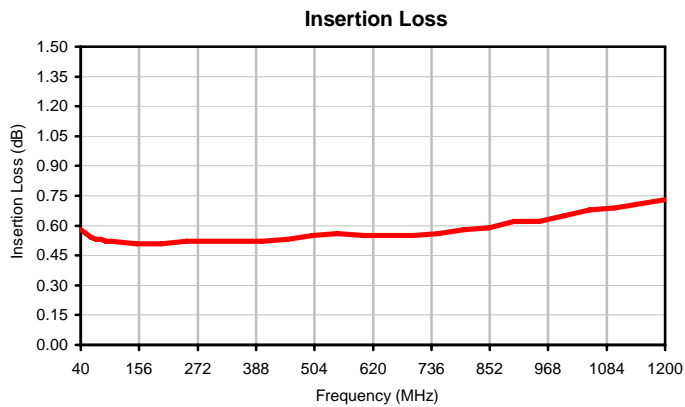
Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	COUPLING (dB)	DIRECTIVITY (dB)	RETURN LOSS (dB)		
				IN	OUT	CPL
40.0	0.58	21.64	17.52	23.40	24.77	23.38
50.0	0.56	21.59	18.38	24.17	25.76	24.05
60.0	0.54	21.54	18.79	24.77	26.63	24.58
70.0	0.53	21.48	19.52	25.24	27.40	25.01
80.0	0.53	21.46	19.93	25.64	28.07	25.34
90.0	0.52	21.43	20.42	25.97	28.65	25.65
100.0	0.52	21.40	20.79	26.18	29.06	25.90
150.0	0.51	21.32	22.55	26.56	29.03	26.72
200.0	0.51	21.26	23.71	26.81	28.91	27.00
250.0	0.52	21.12	25.82	26.55	28.00	27.29
300.0	0.52	21.04	27.40	25.81	26.94	27.36
350.0	0.52	20.97	26.66	25.32	25.96	27.34
400.0	0.52	20.86	27.87	24.72	24.81	26.78
450.0	0.53	20.75	28.12	24.48	23.76	26.35
500.0	0.55	20.52	34.93	23.79	23.55	25.86
550.0	0.56	20.28	30.53	24.26	22.98	25.86
600.0	0.55	20.16	25.62	24.21	23.10	25.83
650.0	0.55	20.11	25.14	24.15	23.07	25.34
700.0	0.55	20.07	24.89	24.78	23.12	25.06
750.0	0.56	19.92	25.50	24.45	23.35	24.52
800.0	0.58	19.72	27.27	25.41	23.80	24.41
850.0	0.59	19.53	23.06	26.52	24.05	24.00
900.0	0.62	19.38	24.56	27.11	24.33	24.10
950.0	0.62	19.26	22.23	28.45	25.42	23.44
1000.0	0.65	19.12	23.38	29.12	26.11	23.57
1050.0	0.68	18.96	21.95	30.51	26.75	22.99
1100.0	0.69	18.81	21.82	31.20	26.49	23.19
1200.0	0.73	18.51	20.42	32.12	27.62	23.06

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Typical Performance Curves



P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 • Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



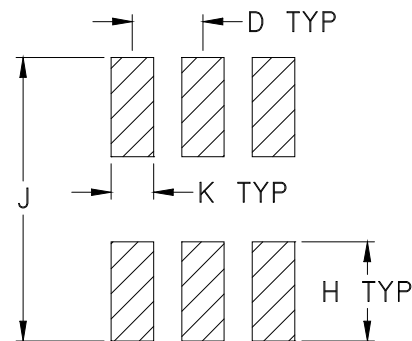
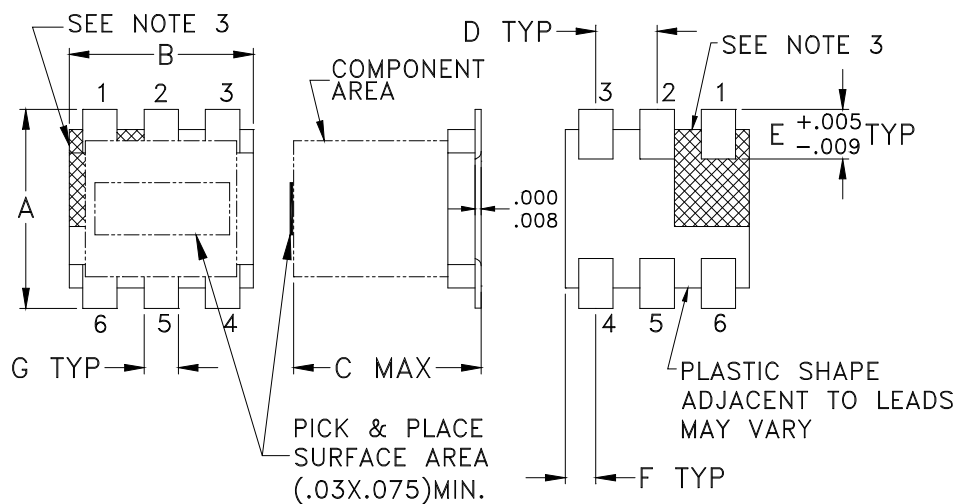
The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

IF/RF MICROWAVE COMPONENTS

REV. X1
TCD-20-4-75+
12/30/2008
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Outline Dimensions

PCB Land Pattern



CASE #	A	B	C	D	E	F	G	H	J	K	WT. GRAM
DB714	.160 (4.06)	.150 (3.81)	.160 (4.06)	.050 (1.27)	.040 (1.02)	.025 (0.64)	.028 (0.71)	.065 (1.65)	.190 (4.83)	.030 (0.76)	.15

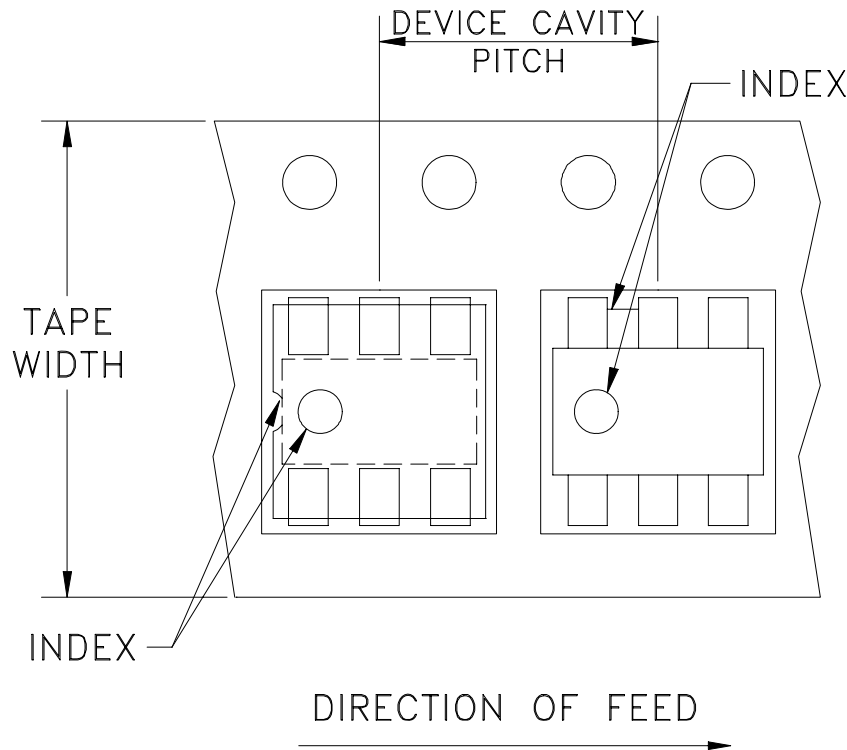
Dimensions are in inches (mm). Tolerances: 2 Pl. ± .01; 3Pl. ± .005

Notes:

- Case material: Plastic.
- Termination finish:
For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.
- Lead #1 identifier shall be located in the cross-hatched area shown. Identifier may be either a molded or marked feature.

Tape & Reel Packaging TR-F47

DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note
12	8	13	1000, 2000
		7	20, 50, 100, 200, 500

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

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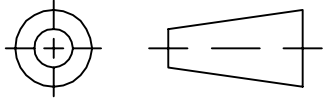
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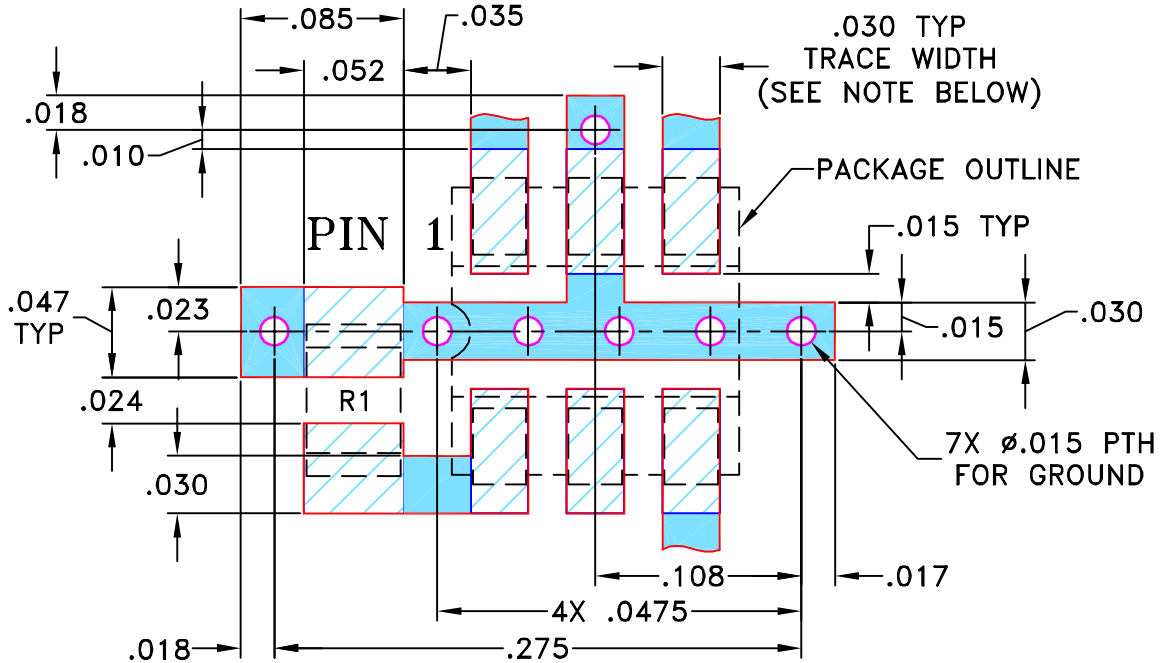
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M73159	NEW RELEASE	08/00	IL	DB
A	M82377	UPDATED DRAWING	07/30/02	AV	LC
B	M102713	UPDATED NOTES	01/12/08	GF	IL

SUGGESTED MOUNTING CONFIGURATION FOR DB714 CASE STYLE, "mm" PIN CONNECTION



RESISTOR R1: 75 ± 1% Ohm, 0805 SIZE

- NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS 0.030" ± 0.002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED

INITIALS

DATE

DIMENSIONS ARE IN INCHES

DRAWN

IL

08/03/00

TOLERANCES ON:

CHECKED

WP

08/08/00

2 PL DECIMALS ± .005

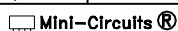
APPROVED

DB

08/09/00

ANGLES ±

FRACTIONS ±



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Mini-Circuits®

13 Neptune Avenue
Brooklyn NY 11235

PL, mm, 75, DB714, TCD, TB-72

SIZE

CODE IDENT

DRAWING NO:

REV:

A

15542

98-PL-010

B

FILE: 98PL010

SCALE:

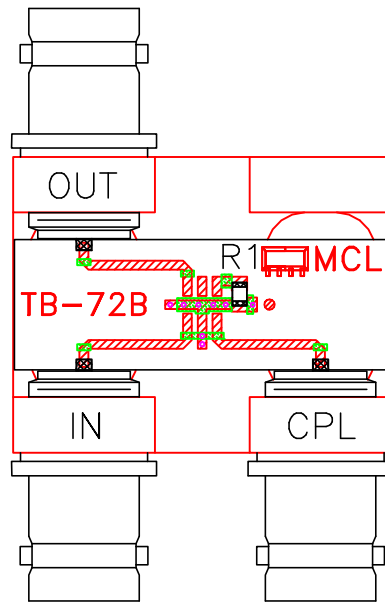
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SHEET:

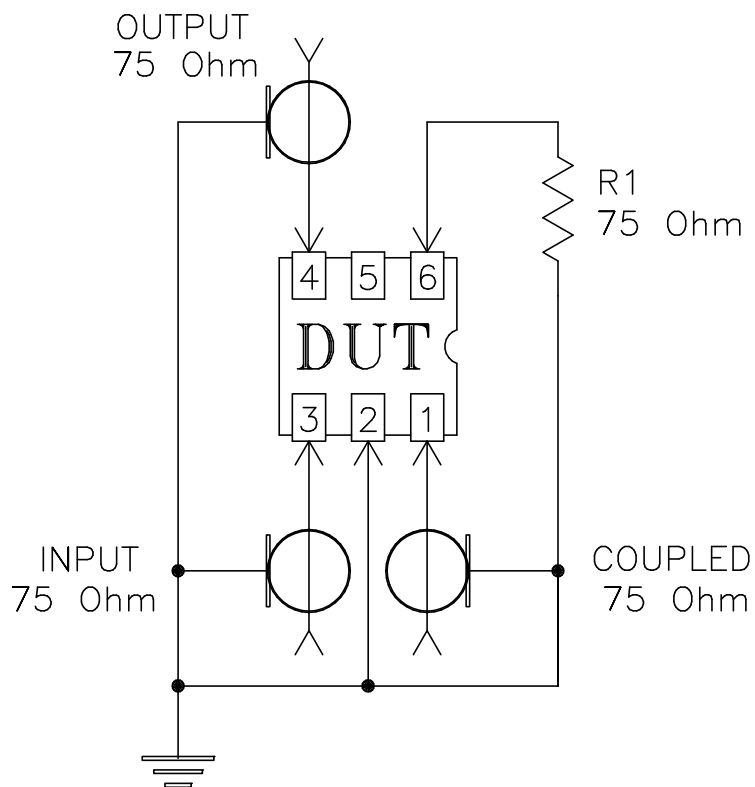
1 OF 1

ASHEETA1.DWG REV:A DATE:01/12/95

Evaluation Board and Circuit




TB-72



Schematic Diagram

Notes:

1. 75 Ohm BNC Female connectors.
2. PCB Material: Rogers R04350 or equivalent,
Dielectric Constant=3.5, Thickness=.030 inch.

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All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215